## **Board Stack Report**

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.010mm	3.5
4		Top Layer	Copper	0.036mm	
5		Dielectric 2	PP-023	0.218mm	4.5
6		GroundPlane	Copper	0.035mm	
7		Dielectric 1	Core-042	0.991mm	4.6
8		VccPlane	Copper	0.035mm	
9		Dielectric 3	PP-023	0.218mm	4.5
10		Bottom Layer	Copper	0.036mm	
11		Bottom Solder	Solder Resist	0.010mm	3.5
12		Bottom Overlay			
13		Bottom Paste			
	Height : 1.589mm				